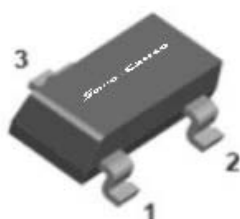
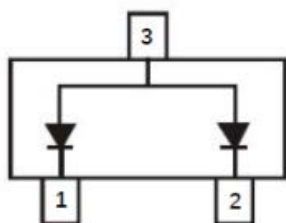


DAP202

Dual Switching Diode



SOT-23

Features

- Moisture sensitivity level 1
- Reverse voltage: 80V
- Average forward current : 100mA

Application

- Signal switching
- High frequency rectifier

Mechanical data

- **Package:** SOT-23
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102

■ Maximum Ratings ($T_a=25^{\circ}\text{C}$ Unless otherwise specified)

Parameter	Symbol	Unit	Value
Device marking code			P
Repetitive peak reverse voltage	V_{RRM}	V	80
Forward current, per leg	I_F	mA	100
Non-repetitive Surge peak forward current @ $t=8.3\text{ms}$ half-sine wave	I_{FSM}	A	2
Non-repetitive Surge peak forward current @ $t=1\text{ms}$ square wave			2
Power dissipation	P_D	mW	200
Junction temperature	T_J	$^{\circ}\text{C}$	-55 to +150
Storage temperature	T_{STG}	$^{\circ}\text{C}$	-55 to +150

DAP202

■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions	Min	Typ	Max
Reverse voltage	V _R	V	I _R =100uA	80		
Forward voltage	V _F	V	I _F =100mA			1.2
Reverse leakage current	I _R	nA	V _R =70V			100
Junction capacitance	C _j	pF	V _R =6V, f=1MHz			3.5
Reverse recovery time	T _{rr}	ns	I _F =I _R =10mA, I _{rr} =0.1*I _R , R _L =100Ω			4

■ Thermal Characteristics

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R _{θJ-A} ⁽¹⁾	°C/W	625
Thermal resistance, junction-to-case	R _{θJ-C} ⁽¹⁾	°C/W	500

Note:

(1) Device mounted on PCB, single-sided copper, with standard footprint

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■ Characteristics

Fig 1: P_D - T_a Curve

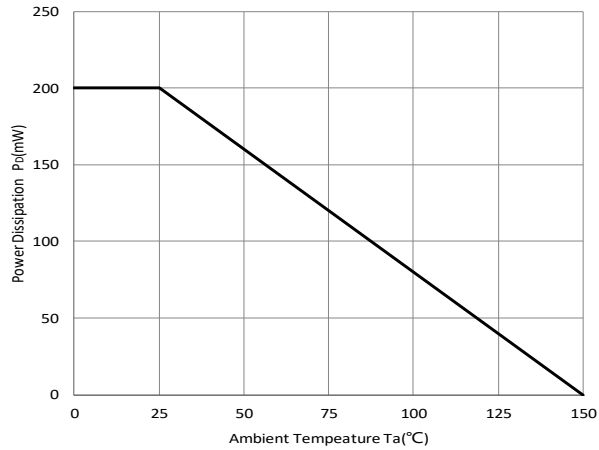


Fig 2: Capacitance Capability

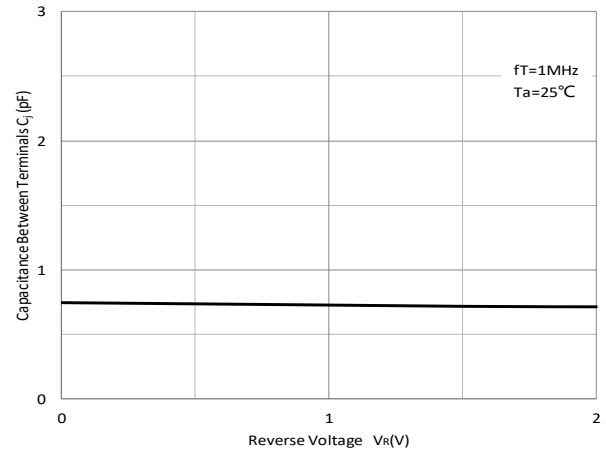


Fig 3: Typical Forward Characteristics

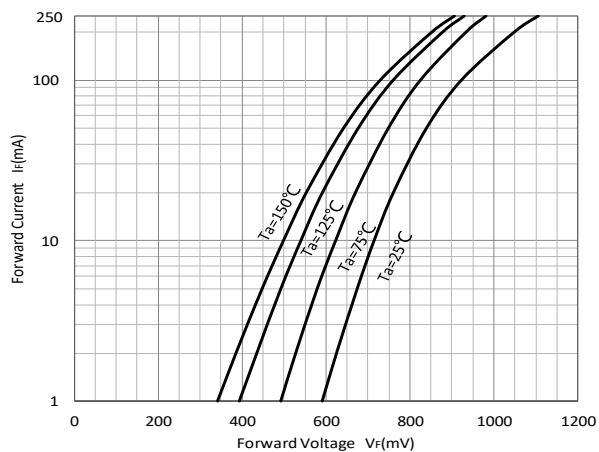
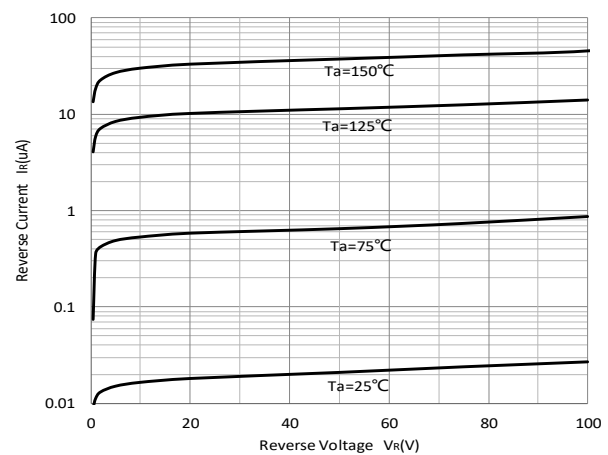


Fig 4: Typical Reverse Characteristics

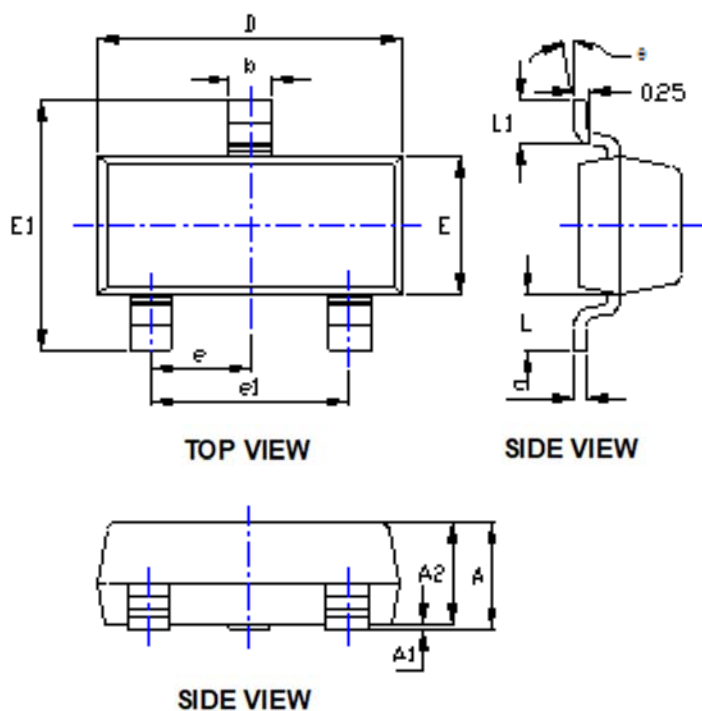


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■ Ordering Information

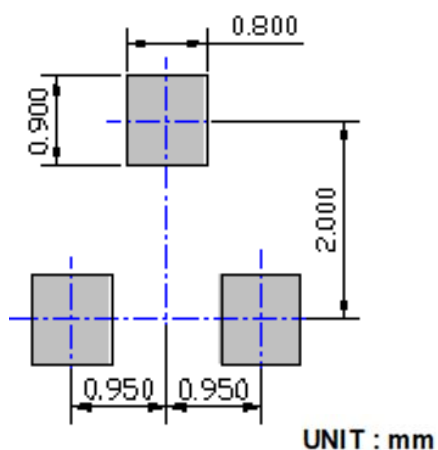
Preferred P/N	Packing code	Unit weight(g)	Minimum package(pcs)	Inner box quantity(pcs)	Outer carton quantity (pcs)	Delivery mode
DAP202	F2	Approximate 0.008	3000	30000	120000	7" reel
DAP202	F4	Approximate 0.008	10000	/	210000	13" reel

■ Outline Dimensions



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.035	0.045	0.900	1.150
A1	0.000	0.004	0.000	0.100
A2	0.035	0.041	0.900	1.050
b	0.012	0.020	0.300	0.500
c	0.004	0.008	0.100	0.200
D	0.110	0.118	2.800	3.000
E	0.047	0.055	1.200	1.400
E1	0.089	0.100	2.250	2.550
e	0.037TYP		0.950TYP	
e1	0.071	0.079	1.800	2.000
L	0.022REF		0.550REF	
L1	0.012	0.020	0.300	0.500
θ	0°	8°	0°	8°

■ Suggested Pad Layout



DAP202

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